

Date: - 30 Jun, 2015

Data Sheet Issue:- 2

# Fast Recovery Diode Type M1609NC200 to M1609NC260

Old Type No.: SM16-26CXC915

#### **Absolute Maximum Ratings**

	VOLTAGE RATINGS	MAXIMUM LIMITS	UNITS
$V_{RRM}$	Repetitive peak reverse voltage, (note 1)	2000-2600	٧
$V_{RSM}$	Non-repetitive peak reverse voltage, (note 1)	2100-2700	V

	OTHER RATINGS	MAXIMUM LIMITS	UNITS
$I_{F(AV)M}$	Maximum average forward current, T <sub>sink</sub> =55°C, (note 2)	1609	Α
$I_{F(AV)M}$	Maximum average forward current. T <sub>sink</sub> =100°C, (note 2)	1035	Α
$I_{F(AV)M}$	Maximum average forward. T <sub>sink</sub> =100°C, (note 3)	618	Α
I <sub>F(RMS)</sub>	Nominal RMS forward current, T <sub>sink</sub> =25°C, (note 2)	3023	Α
I <sub>F(d.c.)</sub>	D.C. forward current, T <sub>sink</sub> =25°C, (note 4)	2582	Α
I <sub>FSM</sub>	Peak non-repetitive surge t <sub>p</sub> =10ms, V <sub>RM</sub> =60%V <sub>RRM</sub> , (note 5)	17500	А
I <sub>FSM2</sub>	Peak non-repetitive surge t <sub>p</sub> =10ms, V <sub>RM</sub> ≤10V, (note 5)	19250	Α
l <sup>2</sup> t	$I^{2}t$ capacity for fusing $t_{p}$ =10ms, $V_{RM}$ =60% $V_{RRM}$ , (note 5)	1.53×10 <sup>6</sup>	$A^2s$
l <sup>2</sup> t	$I^{2}$ t capacity for fusing $t_{p}$ =10ms, $V_{RM}$ ≤10V, (note 5)	1.85×10 <sup>6</sup>	$A^2s$
T <sub>j op</sub>	Operating temperature range	-40 to +150	°C
T <sub>stg</sub>	Storage temperature range	-40 to +150	°C

#### Notes:-

- 1) De-rating factor of 0.13% per °C is applicable for  $T_{j}$  below 25°C.
- 2) Double side cooled, single phase; 50Hz, 180° half-sinewave.
- 3) Single side cooled, single phase; 50Hz, 180° half-sinewave.
- 4) Double side cooled.
- 5) Half-sinewave, 150°C T<sub>i</sub> initial.



# **Characteristics**

	PARAMETER	MIN.	TYP.	MAX.	TEST CONDITIONS (Note 1)	UNITS	
$V_{FM}$	Maximum peak forward voltage	-	-	2.07	I <sub>FM</sub> =2200A	V	
V FM	IMAXIIIIUIII peak lorward voltage	-	-	2.45	I <sub>FM</sub> =3220A	v	
$V_{T0}$	Threshold voltage	-	-	1.31		V	
r <sub>T</sub>	Slope resistance	-	-	0.345		mΩ	
$V_{FRM}$	Maximum forward recovery voltage	-	-	30	di/dt = 1000A/µs, 25°C		
		-	-	100	di/dt = 1000A/µs	V	
I <sub>RRM</sub>	Peak reverse current	-	-	150	Rated V <sub>RRM</sub>	mA	
$Q_{rr}$	Recovered charge	-	800	-		μC	
$Q_{ra}$	Recovered charge, 50% Chord	-	600	735	I <sub>FM</sub> =1000A, t <sub>p</sub> =500μs, di/dt=200A/μs,	μC	
I <sub>rm</sub>	Reverse recovery current	-	375	-	V <sub>r</sub> =50V, 50% Chord.	Α	
t <sub>rr</sub>	Reverse recovery time, 50% Chord	-	3.2	-		μs	
D	The supply and interest is a state of the st	-	-	0.022	Double side cooled	K/W	
R <sub>thJK</sub> Th	Thermal resistance, junction to heatsink	-	-	0.044	Single side cooled		
F	Mounting force	19	-	26		kN	
$W_t$	Weight	-	480	-		g	

# Notes:-

1) Unless otherwise indicated T<sub>j</sub>=150°C.



#### **Notes on Ratings and Characteristics**

# 1.0 Voltage Grade Table

Voltage Grade	V <sub>RRM</sub> (V)	V <sub>RSM</sub>	V <sub>R</sub> dc
20	2000	2100	1250
22	2200	2300	1350
24	2400	2500	1450
26	2600	2700	1550

# 2.0 De-rating Factor

A blocking voltage de-rating factor of 0.13% per °C is applicable to this device for T<sub>i</sub> below 25°C.

#### 3.0 ABCD Constants

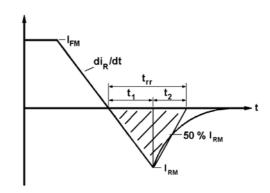
These constants (applicable only over current range of V<sub>F</sub> characteristic in Figure 1) are the coefficients of the expression for the forward characteristic given below:

$$V_F = A + B \cdot \ln(I_F) + C \cdot I_F + D \cdot \sqrt{I_F}$$

where  $I_F$  = instantaneous forward current.

#### 4.0 Reverse recovery ratings

(i)  $Q_{ra}$  is based on 50%  $I_{rm}$  chord as shown in Fig.(a) below.



(ii)  $Q_{rr}$  is based on a 150 $\mu$ s integration time.

(ii) 
$$Q_{rr}$$
 is based on a 150 $\mu$ s integration time.   
I.e. 
$$Q_{rr} = \int\limits_{0}^{150 \, \mu s} i_{rr}.dt$$
(iii) 
$$K \ Factor = \frac{t_1}{t_2}$$

(iii) 
$$K \ Factor = \frac{t_1}{t_2}$$



#### 5.0 Reverse Recovery Loss

The following procedure is recommended for use where it is necessary to include reverse recovery loss.

From waveforms of recovery current obtained from a high frequency shunt (see Note 1) and reverse voltage present during recovery, an instantaneous reverse recovery loss waveform must be constructed. Let the area under this waveform be E joules per pulse. A new sink temperature can then be evaluated from:

$$T_{SINK} = T_{J(MAX)} - E \cdot [k + f \cdot R_{thJK}]$$

Where  $k = 0.2314 \, (^{\circ}\text{C/W})/\text{s}$ 

E = Area under reverse loss waveform per pulse in joules (W.s.)

f = Rated frequency in Hz at the original sink temperature.

 $R_{thJK}$  = d.c. thermal resistance (°C/W)

The total dissipation is now given by:

$$W_{(tot)} = W_{(original)} + E \cdot f$$

NOTE 1 - Reverse Recovery Loss by Measurement

This device has a low reverse recovered charge and peak reverse recovery current. When measuring the charge, care must be taken to ensure that:

- (a) AC coupled devices such as current transformers are not affected by prior passage of high amplitude forward current.
- (b) A suitable, polarised, clipping circuit must be connected to the input of the measuring oscilloscope to avoid overloading the internal amplifiers by the relatively high amplitude forward current signal.
- (c) Measurement of reverse recovery waveform should be carried out with an appropriate critically damped snubber, connected across diode anode to cathode. The formula used for the calculation of this snubber is shown below:

$$R^2 = 4 \cdot \frac{V_r}{C_S \cdot \frac{di}{dt}}$$

Where:  $V_r$  = Commutating source voltage

C<sub>S</sub> = Snubber capacitance R = Snubber resistance

#### 6.0 Snubber Components

When selecting snubber components, care must be taken not to use excessively large values of snubber capacitor or excessively small values of snubber resistor. Such excessive component values may lead to device damage due to the large resultant values of snubber discharge current. If required, please consult the factory for assistance.



#### 7.0 Computer Modelling Parameters

#### 7.1 Device Dissipation Calculations

$$I_{AV} = \frac{-V_{T0} + \sqrt{V_{T0} + 4 \cdot ff^{2} \cdot r_{T} \cdot W_{AV}}}{2 \cdot ff^{2} \cdot r_{T}}$$

Where  $V_{T0} = 1.31 \text{V}, r_T = 0.345 \text{m}\Omega$ 

ff = form factor (normally unity for fast diode applications)

$$W_{AV} = \frac{\Delta T}{R_{th}}$$

$$\Delta T = T_{j(MAX)} - T_K$$

# 7.2 Calculation of V<sub>F</sub> using ABCD Coefficients

The forward characteristic I<sub>F</sub> Vs V<sub>F</sub>, on page 6 is represented in two ways;

- (i) the well established  $V_{T0}$  and  $r_T$  tangent used for rating purposes and
- (ii) a set of constants A, B, C, and D forming the coefficients of the representative equation for V<sub>F</sub> in terms of I<sub>F</sub> given below:

$$V_F = A + B \cdot \ln(I_F) + C \cdot I_F + D \cdot \sqrt{I_F}$$

The constants, derived by curve fitting software, are given in this report for both hot and cold characteristics. The resulting values for  $V_F$  agree with the true device characteristic over a current range, which is limited to that plotted.

	25°C Coefficients	150°C Coefficients
Α	0.23786265	0.049052128
В	0.168731	0.1269428
С	2.0266×10 <sup>-4</sup>	1.80738×10 <sup>-4</sup>
D	1.52099×10 <sup>-3</sup>	0.01378196

#### 8.0 Frequency Ratings

The curves illustrated in figures 8 to 16 are for guidance only and are superseded by the maximum ratings shown on page 1.

#### 9.0 Square wave ratings

These ratings are given for load component rate of rise of forward current of 100 and 500 A/µs.

### 10.0 Duty cycle lines

The 100% duty cycle is represented on all the ratings by a straight line. Other duties can be included as parallel to the first.



#### **Curves**

Figure 1 - Forward characteristics of Limit device

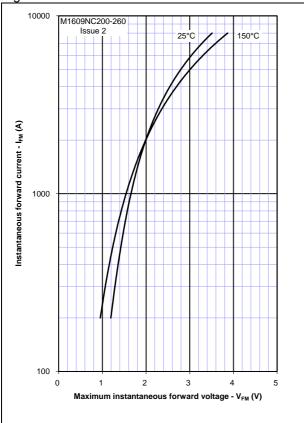


Figure 2 - Maximum forward recovery voltage

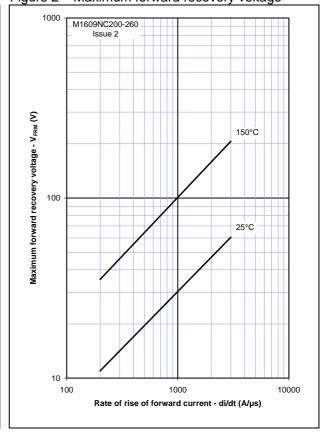


Figure 3 - Recovered charge, Q<sub>rr</sub>

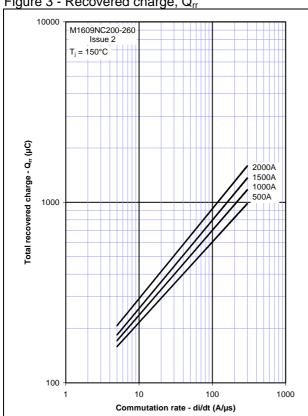
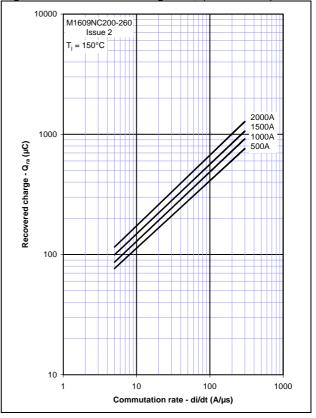
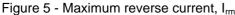


Figure 4 - Recovered charge, Q<sub>ra</sub> (50% chord)







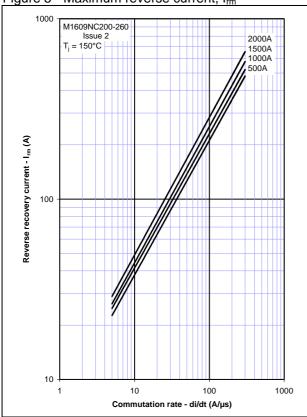
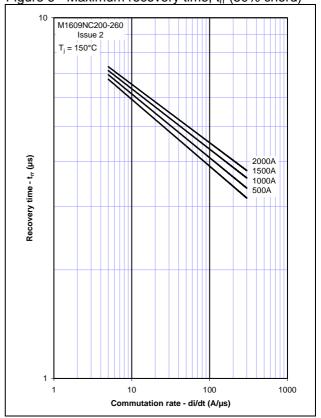


Figure 6 - Maximum recovery time, t<sub>rr</sub> (50% chord)



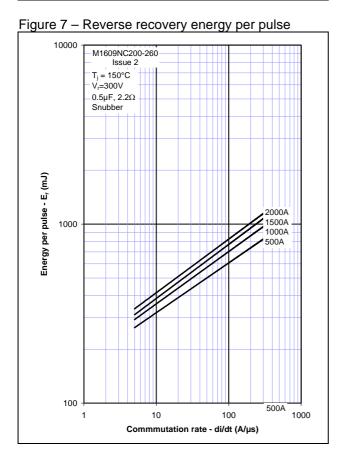


Figure 8 - Sine wave energy per pulse

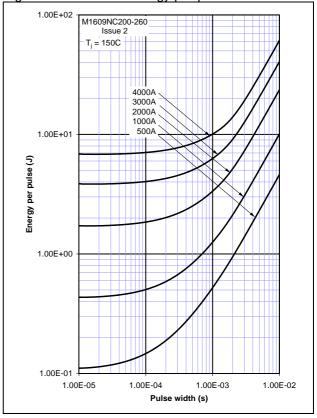




Figure 9 - Sine wave frequency vs. pulse width

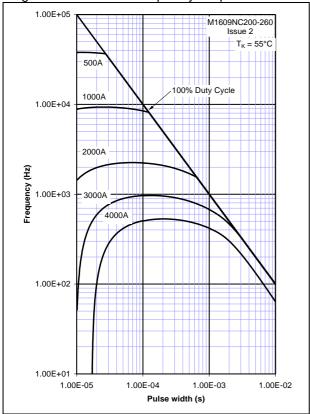
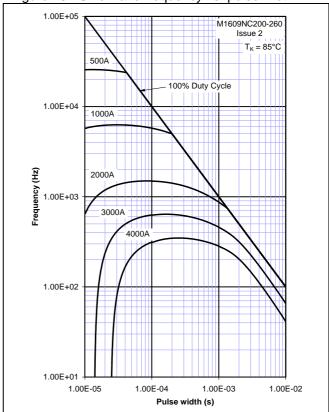


Figure 10 - Sine wave frequency vs. pulse width



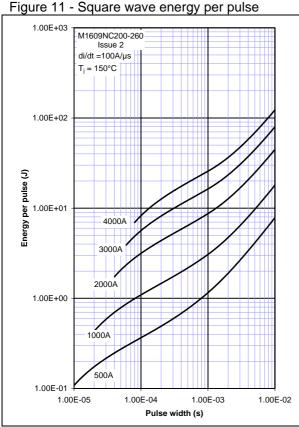


Figure 12 - Square wave energy per pulse

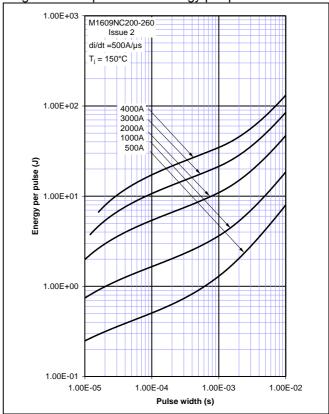




Figure 13 - Square wave frequency vs. pulse width

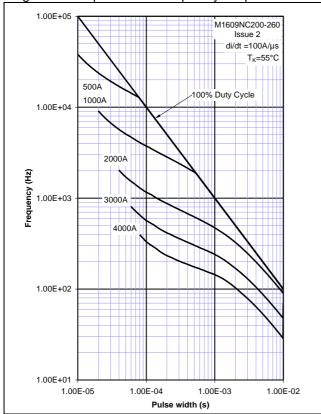


Figure 14 - Square wave frequency vs. pulse width

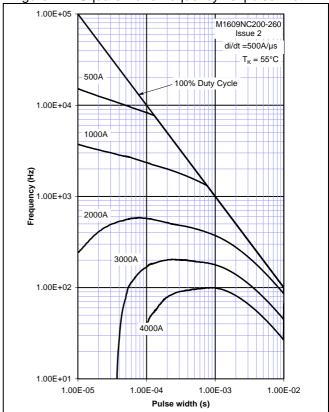


Figure 15 - Square wave frequency vs. pulse width

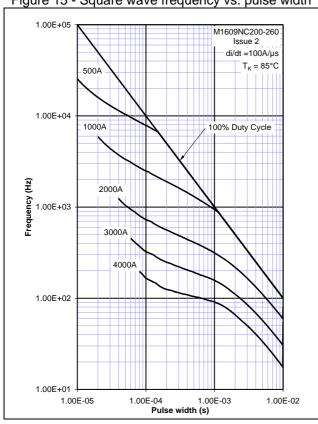
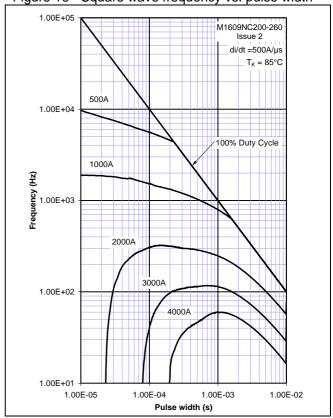
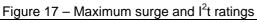
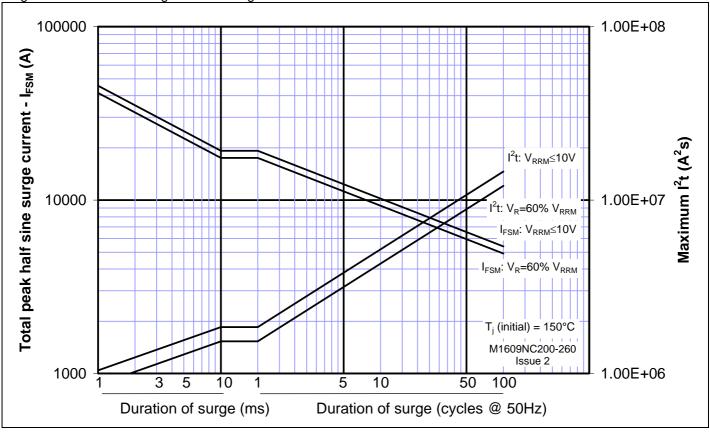


Figure 16 - Square wave frequency vs. pulse width

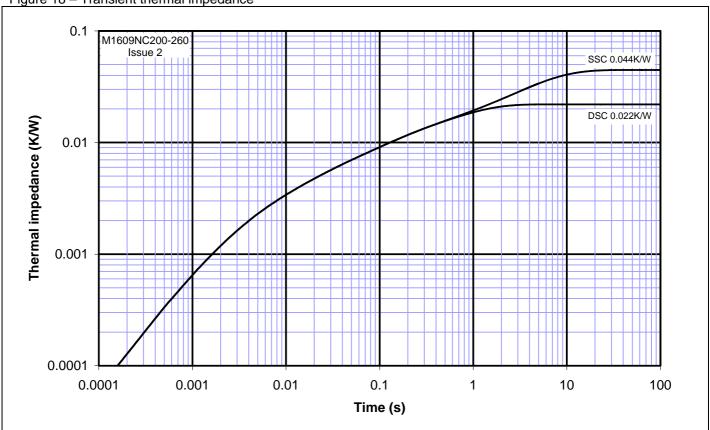






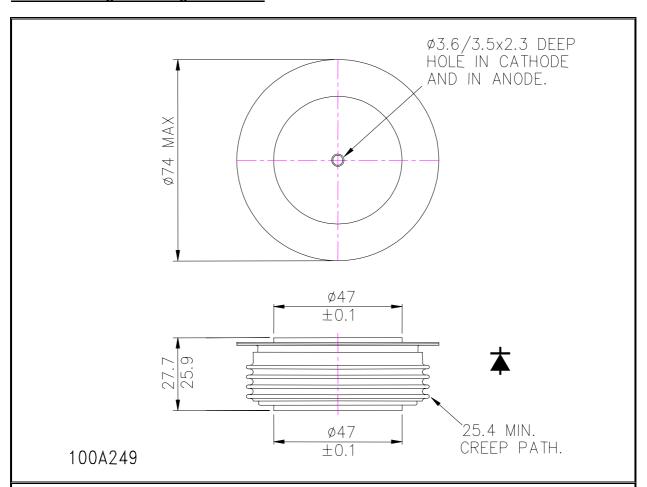








#### **Outline Drawing & Ordering Information**



ORDERING INFORMATION		(Please quote 10 digit code as below)		
M1609	NC	<b>**</b>	0	
Fixed Type Code	Fixed outline code	Voltage code V <sub>DRM</sub> /100 20-26	Fixed code	

Order code: M1609NC240 - 2400V V<sub>RRM</sub>, 27.7mm clamp height capsule.

# I XYS Semiconductor GmbH

Edisonstraße 15 D-68623 Lampertheim Tel: +49 6206 503-0 Fax: +49 6206 503-627 E-mail: marcom@ixys.de

**IXYS** Corporation

1590 Buckeye Drive

Tel: +1 (408) 547 9000

Fax: +1 (408) 496 0670

E-mail: sales@ixys.net

Milpitas CA 95035 7418 USA



# www.westcode.com

www.ixys.com

#### **IXYS UK Westcode Ltd**

Langley Park Way, Langley Park, Chippenham, Wiltshire, SN15 1GE. Tel: +44 (0)1249 444524 Fax: +44 (0)1249 659448

E-mail: sales@ixysuk.com

# **IXYS Long Beach**

IXYS Long Beach, Inc 2500 Mira Mar Ave, Long Beach CĂ 90815

Tel: +1 (562) 296 6584 Fax: +1 (562) 296 6585

E-mail:

service@ixyslongbeach.comT

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